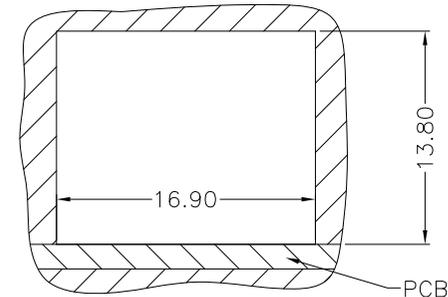
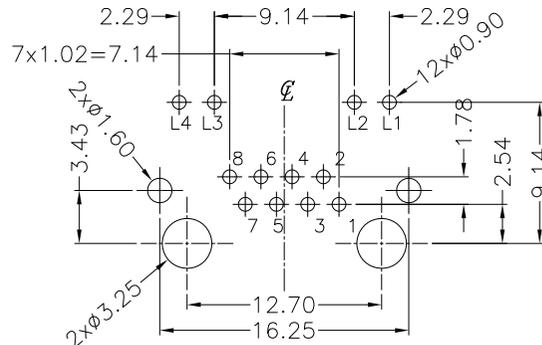
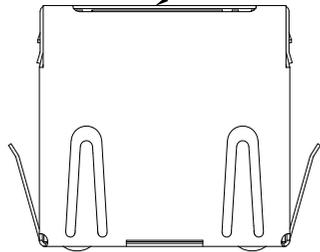


GP Component

REV.	ECN NO.	LOCATIONS	DESCRIPTION	DATE	DESIGN
A0			Initial	2017/12/22	Phebe Su
A1			Change PBT to LCP	2018/01/08	Phebe Su
A2			Change pin length	2019/08/20	Phebe Su

DATE CODE

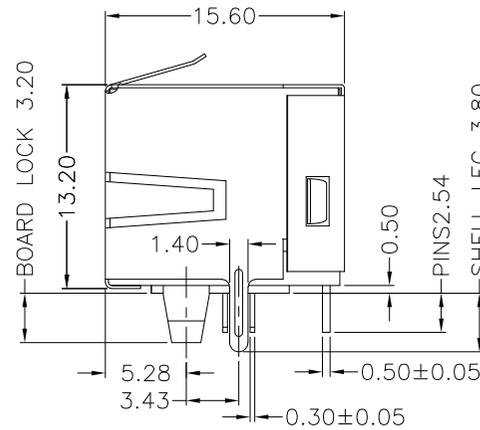
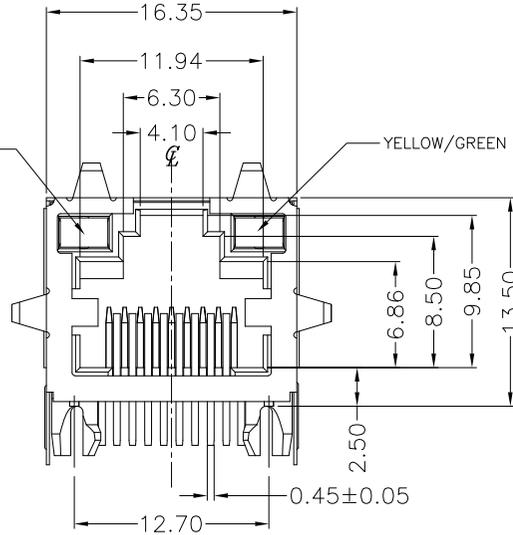


NOTES:

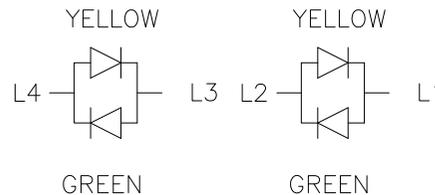
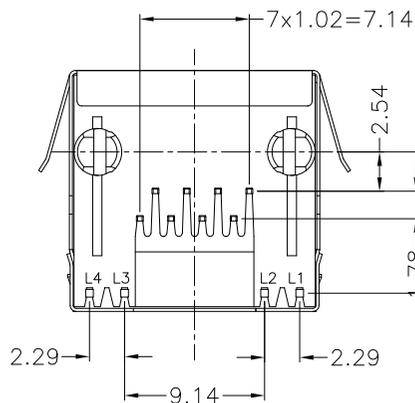
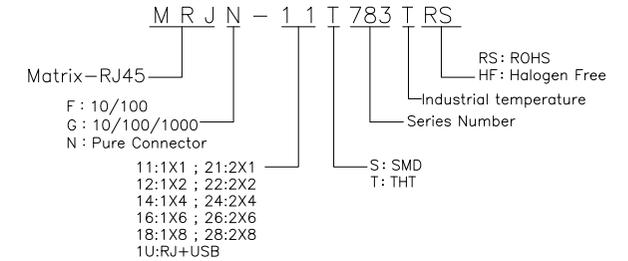
- MATERIALS:
HOUSING: LCP, UL94V-0, BLACK.
CONTACTS: T=0.30 mm PHOSPHOR BRONZE,
50u" NICKEL UNDERPLATE
100u" TIN ON SOLDER TAIL
GOLD FLASH ON CONTACT AREA.
SHELL: STAINLESS T=0.20 NICKEL 30u" Min. OVERALL
- OPERATING TEMPERATURE: -40°C ~ +85°C
- JACK CAVITY MEET IEC60603-7 AND FCC PART 68, SUBPART F

YELLOW/GREEN

YELLOW/GREEN



MATRIX PART NO:



Matrix Electronics Co.,Ltd				
TOLERANCE: X:X X:XX X:XXX ANGLE: ±1°	DESIGN BY : Phebe Su	DATE : 2019/08/20	PART NAME: RJ45 PCB JACK W/SHELL&LED	
UNIT: mm [inch] SCALE:1:1 SIZE:A4	CHECKED BY: Janice Liu	DATE : 2019/08/20	PART NO.	MRJN-11T783TRS
	APPROVED BY1: Richard Hsieh	DATE : 2019/08/20	MOLD NO.	NA
	APPROVED BY2: Richard Hsieh	DATE : 2019/08/20	DRAW NO.	
			SHEET NO.	1 OF 1